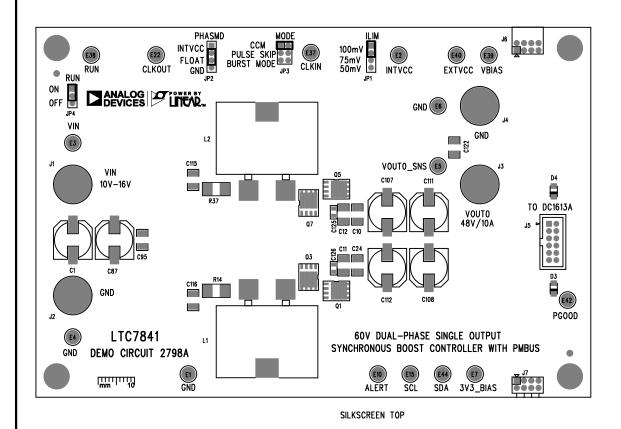
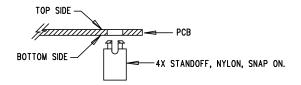
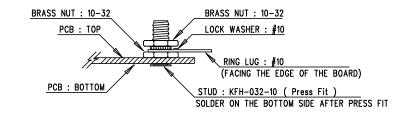
	REVISION HISTORY					
EC0	REV	DESCRIPTION	APP. ENG.	DATE		
-	2	PRODUCTION	XC	09-20-19		



## NOTES: UNLESS OTHERWISE SPECIFIED

- 1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
- ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
- PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
- 4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
- 5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
- DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
- 7. INSTALL 4 STANDOFFS AS SHOWN BELOW:





APPF	ROVALS	ANALOG POWER BY LINEAR COM			
PCB DES.	LT	FOR ADI CUSTO	W.linear.com OMER USE ONLY		
APP ENG.	хс	TITLE: TOP ASSEMBLY DRAWING 60V DUAL-PHASE SINGLE OUTPUT SYNCHRONOUS BOOST CONTROLLER WITH PMBUS			
		SIZE IC NO. LTC7841EUHE DC2798A	2		
SCALE	= NONE	FILENAME: DC2798A-2.PCB SI	HT 1 0F 2		